ESD1014

Low Capacitance ESD Protection Array for High Speed Data Lines Protection

The ESD1014 transient voltage suppressor is designed to protect high speed data lines from ESD, EFT, and lightning.

Features

- Low Capacitance (6 pF Maximum Between I/O Lines and GND)
- ESD Rating of Class 3B (Exceeding 8 kV) per Human Body model and Class C (Exceeding 400 V) per Machine Model
- Protection for the Following IEC Standards: IEC 61000-4-2 (ESD) Level 4 - 30 kV (Contact)
- This is a Pb–Free Device

Typical Applications

- High Speed Communication Line Protection
- USB 1.1 and 2.0 Power and Data Line Protection
- Digital Video Interface (DVI)
- Monitors and Flat Panel Displays
- T1/E1 and T3/E3
- 10/100/1000 Ethernet Protection
- Gigabit Ethernet Protection

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Power Dissipation	P _{pk}	450	W
Maximum Peak Pulse Current 8 x 20 μS @ Τ _A = 25°C	I _{PP}	30	A
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C
Lead Solder Temperature – Maximum (10 Seconds)	ΤL	260	°C
Human Body Model (HBM) Machine Model (MM) IEC 61000-4-2 Contact (ESD)	ESD	16000 400 30000	V

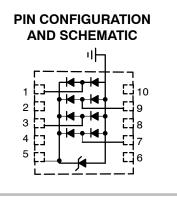
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



ON Semiconductor®

http://onsemi.com

LOW CAPACITANCE DIODE TVS ARRAY





MARKING DIAGRAM

UDFN10 CASE 517AN

А

Υ

W



1014	= Specific Device

- = Assembly Location
- = Year
- = Work Week
- = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
ESD1014MUTAG	UDFN10 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ESD1014

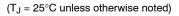
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse Working Voltage	V _{RWM}	(Note 1)			3.3	V
Breakdown Voltage	V _{BR}	I _T =1 mA, (Note 2)	5.0	5.3		V
Reverse Leakage Current	I _R	V _{RWM} = 3.3 V			5.0	μA
Clamping Voltage	V _C	I _{PP} = 1 A, pin 5 to GND			6.2	V
Clamping Voltage	V _C	I _{PP} = 1 A			7.5	V
Clamping Voltage	V _C	I _{PP} = 10 A			9.0	V
Clamping Voltage	V _C	I _{PP} = 25 A			11	V
Maximum Peak Pulse Current	I _{PP}	8x20 μs Waveform			30	А
Junction Capacitance	CJ	V_R = 0 V, f=1 MHz between I/O Pins and GND		3.8	5.0	pF
Junction Capacitance	CJ	V _R = 0 V, f=1 MHz between I/O Pins		1.5	3.0	pF

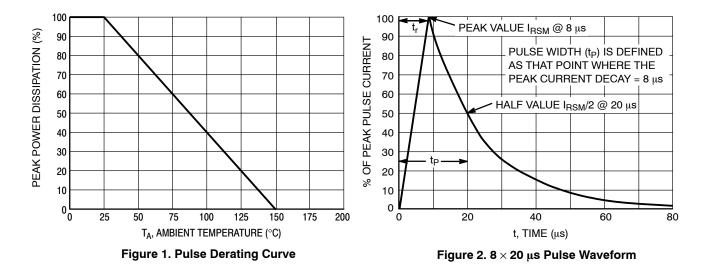
ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}C$ unless otherwise specified)

1. TVS devices are normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal or greater than the DC or continuous peak operating voltage level.

2. V_{BR} is measured at pulse test current I_T.

TYPICAL PERFORMANCE CURVES

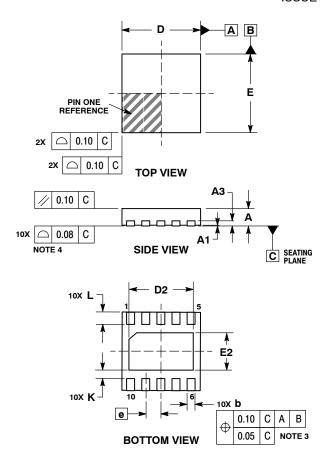


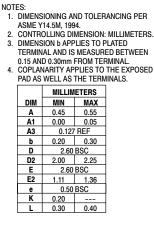


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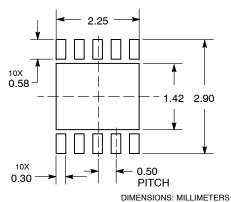
PACKAGE DIMENSIONS

UDFN10 2.6x2.6, 0.5P CASE 517AN ISSUE B





SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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